

• General Description

The AGM30P05A combines advanced trench MOSFET technology with a low resistance package to provide extremely low $R_{\text{DS(ON)}}$.

This device is ideal for load switch and battery protection applications.

Features

- Advance high cell density Trench technology
- Low R_{DS(ON)} to minimize conductive loss
- Low Gate Charge for fast switching
- Low Thermal resistance

Application

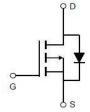
- MB/VGA Vcore
- SMPS 2nd Synchronous Rectifier
- POL application
- BLDC Motor driver

Product Summary

BVDSS	RDSON	ID
-30V	5.5mΩ	-75A

PDFN5*6 Pin Configuration





Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
AGM30P05A	AGM30P05A	PDFN5*6	330mm	12mm	3000

Table 1. Absolute Maximum Ratings (TC=25℃)

Symbol	Parameter	Value	Unit
VDS	Drain-Source Voltage (VGS=0V)	-30	V
VGS	Gate-Source Voltage (VDS=0V)	±20	V
ID	Drain Current-Continuous(Tc=25℃) (Note 1)	-75	А
	Drain Current-Continuous(Tc=100℃)	-50	Α
IDM (pluse)	Drain Current-Continuous@ Current-Pulsed (Note 2)	-240	Α
PD	Maximum Power Dissipation(Tc=25℃)	59.5	w
	Maximum Power Dissipation(Tc=100℃)	24	W
EAS	Avalanche energy (Note 3)	93	mJ
TJ,TSTG	Operating Junction and Storage Temperature Range	-55 To 150	${\mathbb C}$

Table 2. Thermal Characteristic

Symbol	Parameter	Тур	Max	Unit
RθJA	Thermal Resistance Junction-ambient (Steady State) ¹			°C/W
RθJC	Thermal Resistance Junction-Case ¹		2.1	°C/W



Table 3. Electrical Characteristics (TJ=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
On/Off Sta	tes					
BVDSS	Drain-Source Breakdown Voltage	VGS=0V ID=250μA	-30			V
IDSS	Zero Gate Voltage Drain Current	VDS=-30V,VGS=0V			-1.0	μΑ
IGSS	Gate-Body Leakage Current	VGS=±20V,VDS=0V			±100	nA
VGS(th)	Gate Threshold Voltage	VDS=VGS,ID=-250µA	-1.2	-1.6	-2.1	V
gFS	Forward Transconductance	VDS=-10V,ID=-10A		20		S
RDS(on)	Drain-Source On-State Resistance	VGS=-10V, ID=-15A		5.5	7.0	mΩ
1.05(611)		VGS=-4.5V, ID=-20A		8.5	11.3	mΩ
Dynamic C	Characteristics					
Ciss	Input Capacitance			2497		pF
Coss	Output Capacitance	VDS=-30V,F=1MHZ		240		pF
Crss	Reverse Transfer Capacitance			230		pF
Rg	Gate resistance	VGS=0V, VDS=0V,f=1.0MHz				Ω
Switching	Times					
td(on)	Turn-on Delay Time			14		nS
tr	Turn-on Rise Time			20		nS
td(off)	Turn-Off Delay Time	VGS=-10V,VDS=-15V, ID=-30A,RI=3.0Ω		56		nS
tf	Turn-Off Fall Time			48		nS
Qg	Total Gate Charge			32		nC
Qgs	Gate-Source Charge	VGS=-10V, VDS=-15V, ID=-20A		6.6		nC
Qgd	Gate-Drain Charge			8.0		nC
Source-Dr	ain Diode Characteristics					
ISD	Source-Drain Current(Body Diode)				-75	А
VSD	Forward on Voltage	VGS=0V,IS=-15A			-1.2	V
trr	Reverse Recovery Time	IF=-15A ,			-	ns
Qrr	Reverse Recovery Charge	dl/dt=-500A/µs , TJ=25℃				nc

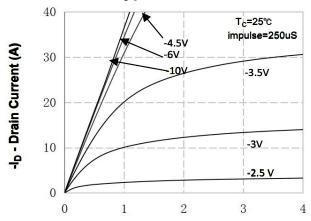
Notes 1. The maximum current rating is package limited.

Notes 2.Repetitive Rating: Pulse width limited by maximum junction temperature

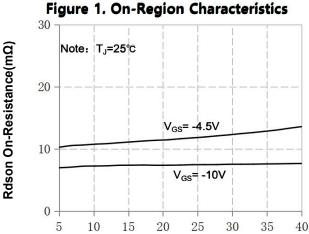
Notes 3.EAS condition: TJ=25℃



P- Channel Typical Characteristics



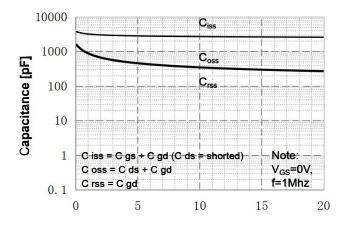
-Vds Drain-Source Voltage (V)



-ID - Drain Current (A)

Figure 3. On-Resistance Variation vs

Drain Current and Gate Voltage



-V_{DS} Drain-to-Source Voltage (V) Figure 5. Capacitance Characteristics

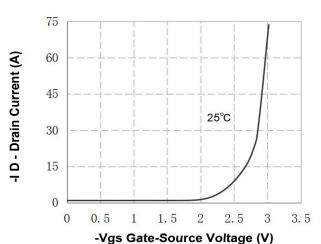
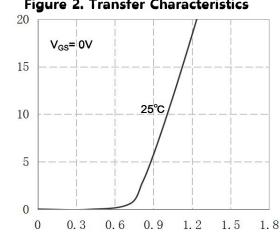
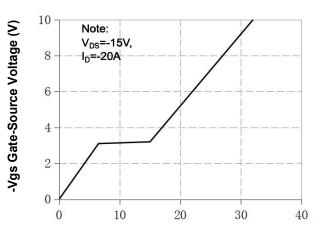


Figure 2. Transfer Characteristics



-VF ,Forward Voltage (V)
Figure 4. Body Diode Forward Voltage
Variation with Source Current
and Temperature



Qg Gate Charge (nC)
Figure 6. Gate Charge Characteristics

I_F Forward Current (A)



P- Channel Typical Characteristics (Continued)

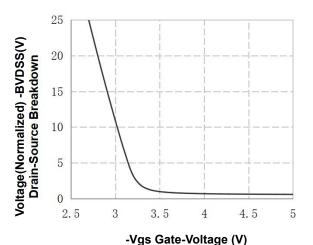


Figure 7. Breakdown Voltage Variation vs Gate-Voltage

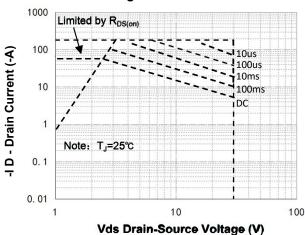
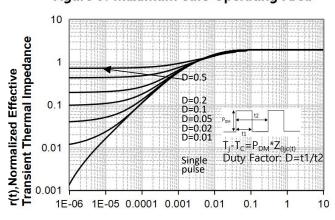


Figure 9. Maximum Safe Operating Area



Posicon), (Normalized) (mR)

Drain-Source On Resistance

100

2.5 3 3.5 4 4.5 5

Figure 8. On-Resistance Variation vs Gate Voltage

-Vgs Gate-Voltage (V)

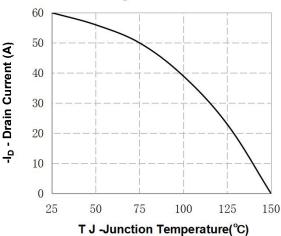


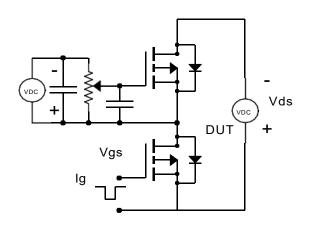
Figure 10. Maximum PContinuous Drain Currentvs Case Temperature

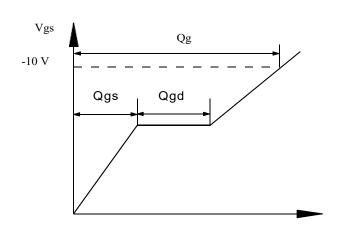
Square Wave Pluse Duration(sec)

Figure 11. Transient Thermal Response Curve

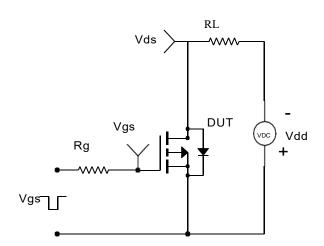


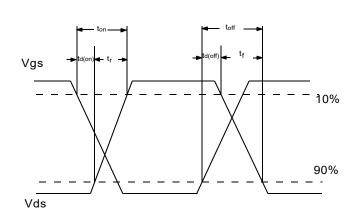
Gate Charge Test Circuit & Waveform



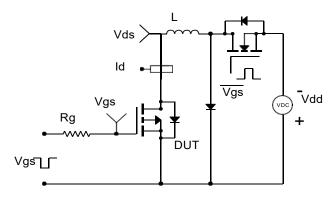


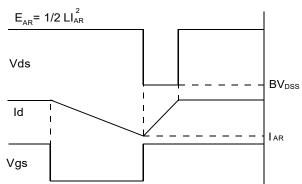
Resistive Switching Test Circuit & Waveforms





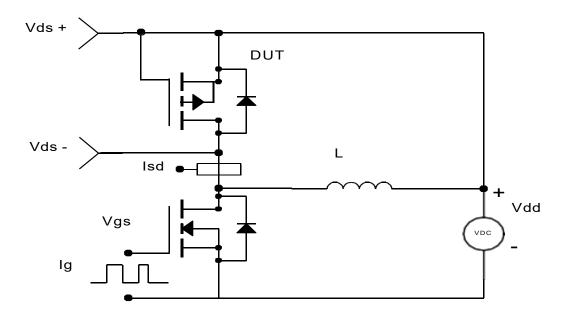
Unclamped Inductive Switching Test Circuit & Waveforms



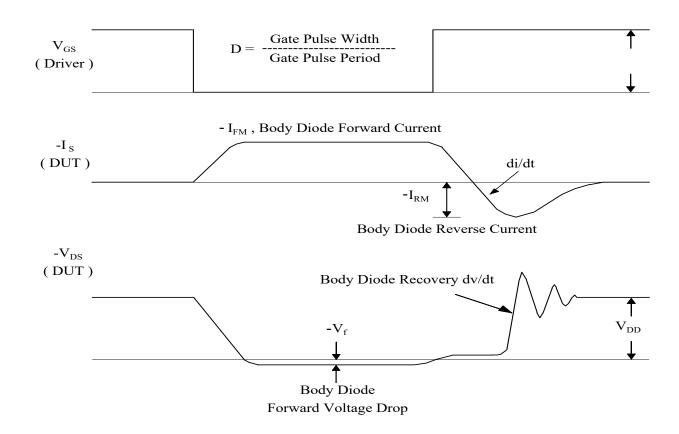




Peak Diode Recovery dv/dt Test Circuit & Waveforms

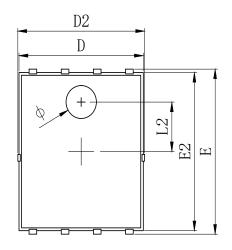


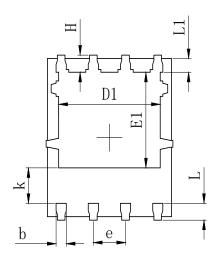
- dv/dt controlled by RG
- ISD controlled by pulse period



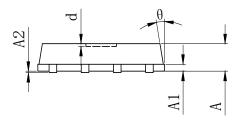


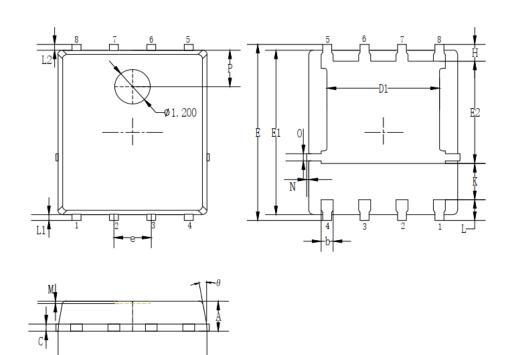
•Dimensions (PDFN5*6)





SYMBOL	MILLIMETER			
SIMDUL	MIN	Тур.	MAX	
A	0.900	1.000	1.100	
A1		0.254 REF.		
A2		0~0.05		
D	4.824	4. 900	4. 976	
D1	3.910	4.010	4.110	
D2	4.924	5.000	5. 076	
Е	5. 924	6.000	6.076	
E1	3. 375	3. 475	3. 575	
E2	5.674	5. 750	5. 826	
b	0.350	0.400	0.450	
е		1.270 TYP.		
L	0.534	0.610	0.686	
L1	0.424	0.500	0. 576	
L2	1.800 REF.			
k	1.190	1.290	1.390	
Н	0.549	0.625	0.701	
θ	8°	10°	12°	
ф	1.100	1. 200	1. 300	
d			0.100	





0.1.1	Millimeters			
Symbols	MIN.	NOM.	MAX.	
A	0.90	1.05	1.20	
b	0.35	0. 40	0.50	
С	0.20	0.25	0.35	
D	4. 90	5. 05	5. 20	
D1	3.72	3.82	3. 92	
E	6.00	6. 15	6.30	
E1	5. 60	5. 75	5. 90	
E2	3. 47	3.57	3.67	
e	1	. 27 BSC		
Н	0.48	0.58	0.68	
K	1.17	1.27	1.37	
L	0.64	0.74	0.84	
L1/L2	0.20 REF.			
θ	8°	10°	12°	
M	0.08 REF.			
N	0	1	0.15	
0	0.25 REF.			
P	1.28 REF.			



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